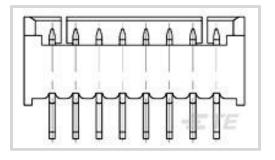
1734598-8 - ACTIVE

TE Internal #: 1734598-8 PCB Mount Header, Vertical, Wire-to-Board, 8 Position, 1.25 mm [. 049 in] Centerline, Fully Shrouded, Tin, Through Hole - Solder, Signal, Natural

View on TE.com >



Connectors > PCB Connectors > PCB Headers & Receptacles > AMP HPI 1.25 mm Headers



Connector System: Wire-to-Board

Number of Positions: 8

Number of Rows: 1

Centerline (Pitch): 1.25 mm [.049 in]

PCB Mount Orientation: Vertical

All AMP HPI 1.25 mm Headers (100)

Features

Product Type Features

Connector System	Wire-to-Board
Header Type	Fully Shrouded
Sealable	No
Connector & Contact Terminates To	Printed Circuit Board
PCB Connector Assembly Type	PCB Mount Header
Configuration Features	
Connector Contact Load Condition	Fully Loaded
Number of Positions	8
Number of Rows	1
PCB Mount Orientation	Vertical
Electrical Characteristics	
Operating Voltage	100 VAC
Body Features	
Primary Product Color	Natural
Contact Features	
PCB Contact Termination Area Plating Material Thickness	3.08 μm[120 μin]
Contact Layout	Inline

PCB Mount Header, Vertical, Wire-to-Board, 8 Position, 1.25 mm [.049 in] Centerline, Fully Shrouded, Tin, Through Hole - Solder, Signal, Natural



Jsage Conditions	
Connector Width	3.2 mm[.126 in]
Connector Height	4.7 mm[.185 in]
Connector Length	11.75 mm[.463 in]
Dimensions	
Centerline (Pitch)	1.25 mm[.049 in]
Housing Material	PA 9T GF
lousing Features	
PCB Mount Retention	Without
PCB Mount Alignment	Without
Mating Alignment	With
Connector Mounting Type	Board Mount
Mating Retention	Without
Mating Alignment Type	Polarization
/lechanical Attachment	
Termination Method to Printed Circuit Board	Through Hole - Solder
Termination Post & Tail Length	1.7 mm[.067 in]
Rectangular Termination Post & Tail Width	.35 mm[.014 in]
Rectangular Termination Post & Tail Thickness	.3 mm[.012 in]
ermination Features	
Contact Current Rating (Max)	.8 A
Contact Type	Pin
Contact Mating Area Plating Material	Tin
Contact Base Material	Phosphor Bronze
PCB Contact Termination Area Plating Material	Tin
Contact Underplating Material	Nickel
Contact Mating Area Plating Material Finish	Matte
PCB Contact Termination Area Plating Material Finish	Matte
Mating Tab Thickness	.3 mm[.012 in]

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08/26/2023 06:09AM | Page 2

PCB Mount Header, Vertical, Wire-to-Board, 8 Position, 1.25 mm [.049 in] Centerline, Fully Shrouded, Tin, Through Hole - Solder, Signal, Natural



Circuit Application	Signal
Industry Standards	
UL Flammability Rating	UL 94V-0
Packaging Features	
Packaging Quantity	52
Packaging Type	Box, Tube
For compliance documentation, visit the product page on TE.com> EU RoHS Directive 2011/65/EU	Compliant
EU RoHS Directive 2011/65/EU	Compliant
EU ELV Directive 2000/53/EC	Compliant
China RoHS 2 Directive MIIT Order No 32, 2016	No Restricted Materials Above Threshold
EU REACH Regulation (EC) No. 1907/2006	Current ECHA Candidate List: JUNE 2023 (235) Candidate List Declared Against: JAN 2022 (223) Does not contain REACH SVHC
Halogen Content	Not Low Halogen - contains Br or Cl > 900 ppm.
Solder Process Capability	Wave solder capable to 265°C

Product Compliance Disclaimer

This information is provided based on reasonable inquiry of our suppliers and represents our current actual knowledge based on the information they provided. This information is subject to change. The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, mercury, PBB, PBDE, DBP, BBP, DEHP, DIBP, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2011/65/EU (RoHS2). Finished electrical and electronic equipment products will be CE marked as required by Directive 2011/65/EU. Components may not be CE marked. Additionally, the part numbers that TE has identified as EU ELV compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, and mercury, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2000/53/EC (ELV). Regarding the REACH Regulation, the information TE provides on SVHC in articles for this part number is based on the latest European Chemicals Agency (ECHA) 'Guidance on requirements for substances in articles' posted at this URL: https://echa.europa.eu/guidance-documents/guidance-onreach

Compatible Parts

PCB Mount Header, Vertical, Wire-to-Board, 8 Position, 1.25 mm [.049 in] Centerline, Fully Shrouded, Tin, Through Hole - Solder, Signal, Natural





Customers Also Bought



TE Part #1734598-4



TE Part #6-2176307-7

Documents

Product Drawings 1.25 WTB HDR DIP, 8 POS

English

CAD Files

3D PDF

3D

Customer View Model ENG_CVM_CVM_1734598-8_R.2d_dxf.zip

English

Customer View Model

ENG_CVM_CVM_1734598-8_R.3d_igs.zip

English

Customer View Model

ENG_CVM_CVM_1734598-8_R.3d_stp.zip

English

By downloading the CAD file I accept and agree to the **Terms and Conditions** of use

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08/26/2023 06:09AM | Page 4

PCB Mount Header, Vertical, Wire-to-Board, 8 Position, 1.25 mm [.049 in] Centerline, Fully Shrouded, Tin, Through Hole - Solder, Signal, Natural



Datasheets & Catalog Pages

HPI Connectors QRG

English

Product Specifications

Application Specification

English

Product Environmental Compliance Product Compliance

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Product Compliance

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